PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5156978

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT	
NATURE OF CONVEYANCE:	Corrective Assignment to correct the 3RD INVENTOR'S EXECUTION DATE previously recorded on Reel 046942 Frame 0939. Assignor(s) hereby confirms the ASSIGNMENT.	

CONVEYING PARTY DATA

Name	Execution Date
SONG GUO	07/30/2018
SANH D. TANG	08/15/2018
VLAD TEMCHENKO	08/28/2018
SHIVANI SRIVASTAVA	08/23/2018

RECEIVING PARTY DATA

Name:	MICRON TECHNOLOGY, INC.
Street Address:	8000 SOUTH FEDERAL WAY
Internal Address:	MAILSTOP 1-507
City:	BOISE
State/Country:	IDAHO
Postal Code:	83707-0006

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16111499

CORRESPONDENCE DATA

Fax Number: (801)531-9168

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 8015321922

Email:djpfeil@traskbritt.comCorrespondent Name:TRASK BRITT, P.CAddress Line 1:P.O. BOX 2550

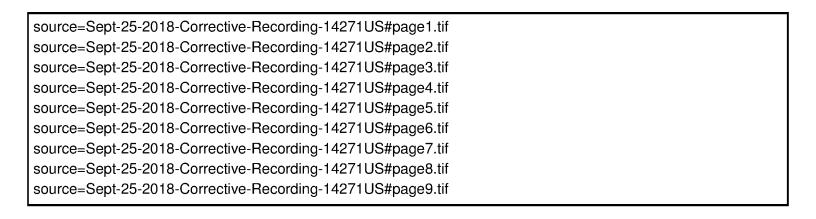
Address Line 4: SALT LAKE CITY, UTAH 84110

ATTORNEY DOCKET NUMBER:	2269-14271(2016-0775.00)
NAME OF SUBMITTER:	JESSE M. FLORES
SIGNATURE:	/Jesse M. Flores/
DATE SIGNED:	09/25/2018
	1 00/12/13 10

Total Attachments: 9

PATENT REEL: 047139 FRAME: 0929

505110218



PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5108896

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name		Execution Date
SONG GUO		07/30/2018
SANH D. TANG		08/15/2018
VLAD TEMCHENKO	08/28/2018	08/18/2018
SHIVANI SRIVASTAVA		08/23/2018

RECEIVING PARTY DATA

Name:	MICRON TECHNOLOGY, INC.
Street Address:	8000 SOUTH FEDERAL WAY
Internal Address:	MAILSTOP 1-507
City:	BOISE
State/Country:	IDAHO
Postal Code:	83707-0006

PROPERTY NUMBERS Total: 1

-	Property Type	Number	,
	Application Number:	16111499	

CORRESPONDENCE DATA

Fax Number: (801)531-9168

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 801-532-1922

Email: djpfeil@traskbritt.com

Correspondent Name: TRASK BRITT, P.C./ MICRON TECHNOLOGY

Address Line 1: P.O. BOX 2550

Address Line 4: SALT LAKE CITY, UTAH 84110

ATTORNEY DOCKET NUMBER:	2269-14271(2016-0775.00)
NAME OF SUBMITTER:	JESSE M. FLORES
SIGNATURE:	/Jesse M. Flores/
DATE SIGNED:	08/24/2018

Total Attachments: 8

source=Aug-24-2018-Assignment-14271US#page1.tif

Attorney Docket No. 2269-P14271US (2016-0775.00/US)

ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, each undersigned ASSIGNOR does hereby:

SELL, ASSIGN AND TRANSFER to MICRON TECHNOLOGY, INC. ("ASSIGNEE"), a Corp[oration of the State of Delaware, having a place of business at 8000 South Federal Way, Mailstop 1-507, Boise, ID 83707-0006, the entire right, title and interest for the United States and all foreign countries in and to any and all improvements that are disclosed in the Application for United States Letters Patent that has been executed by each undersigned ASSIGNOR concurrently herewith, and titled METHODS OF FORMING SEMICONDUCTOR DEVICES USING ASPECT RATIO DEPENDENT ETCHING EFFECTS, AND RELATED SEMICONDUCTOR DEVICES, MEMORY DEVICES, AND ELECTRONIC SYSTEMS, such application and all divisional, continuing, substitute, renewal, reissue and all other applications for patent or the legal equivalent thereof that have been or may be filed in the United States and all foreign countries relating to any of such improvements; all original, reexamined and reissued patents that have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application made in the United States;

AUTHORIZE the ASSIGNEE to apply for and receive any and all United States and foreign patents relating to such improvements in its own name;

AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to and in the name of the ASSIGNEE:

WARRANT AND COVENANT that no assignment, grant, mortgage, license or other agreement or encumbrance affecting the rights and property herein conveyed has been or will be made or entered into by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT, when requested and at the expense of the ASSIGNEE, to carry out in good faith the intent and purpose of this Assignment, to execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications relating to my and all such improvements, to execute all rightful oaths, declarations, assignments, powers of attorney and other papers; to communicate to the ASSIGNEE all facts and provide to the ASSIGNEE all documents and things known and accessible to the undersigned relating to such improvements and the history thereof, and testify as to the same in any interference, fitigation or other proceeding relating thereto; and generally to do everything possible that the ASSIGNEE shall

consider desirable for vesting title to such improvements in the ASSIGNEE, and to secure, maintain, defend and enforce valid and enforceable patent protection for such improvements;

AGREE AND ACKNOWLEDGE that the SALE, ASSIGNMENT AND TRANSFER of rights and property set forth herein is and shall be IRREVOCABLE and BINDING upon the heirs, assigns, representatives and successors of each undersigned ASSIGNOR and EXTEND to the successors, assigns and nominees of the ASSIGNEE.

ASSIGNORS: Song Guo Residing at: 10814 West Alfina Drive, Boise, ID 83709	Date:	07/30/2018
Sanh D. Tang Residing at: 2725 E. Deer Flat Rd., Kuna, ID 83634	Date:	***************************************
Vlad Temchenko Residing at: 100 East Parkway Drive, Boise. ID 83706	Date;	
Shivani Srivastava Residing at: 4068 S. Federal Way, Apt. #I-107. Boise, ID !	Date:	

Attorney Docket No. 2269-P14271US (2016-0775.00/US)

ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, each undersigned ASSIGNOR does hereby:

SELL, ASSIGN AND TRANSFER to MICRON TECHNOLOGY, INC. ("ASSIGNEE"), a Corp[oration of the State of Delaware, having a place of business at 8000 South Federal Way, Mailstop 1-507, Boise, ID 83707-0006, the entire right, title and interest for the United States and all foreign countries in and to any and all improvements that are disclosed in the Application for United States Letters Patent that has been executed by each undersigned ASSIGNOR concurrently herewith, and titled METHODS OF FORMING SEMICONDUCTOR DEVICES USING ASPECT RATIO DEPENDENT ETCHING EFFECTS, AND RELATED SEMICONDUCTOR DEVICES, MEMORY DEVICES, AND ELECTRONIC SYSTEMS, such application and all divisional, continuing, substitute, renewal, reissue and all other applications for patent or the legal equivalent thereof that have been or may be filed in the United States and all foreign countries relating to any of such improvements; all original, reexamined and reissued patents that have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application made in the United States;

AUTHORIZE the ASSIGNEE to apply for and receive any and all United States and foreign patents relating to such improvements in its own name.

AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to and in the name of the ASSIGNEE;

WARRANT AND COVENANT that no assignment, grant, mongage, license or other agreement or encumbrance affecting the rights and property herein conveyed has been or will be made or entered into by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT, when requested and at the expense of the ASSIGNEE, to carry out in good faith the intent and purpose of this Assignment, to execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications relating to any and all such improvements; to execute all rightful oaths, declarations, assignments, powers of attorney and other papers; to communicate to the ASSIGNEE all facts and provide to the ASSIGNEE all documents and things known and accessible to the undersigned relating to such improvements and the history thereof, and testify as to the same in any interference, litigation or other proceeding relating thereto; and generally to do everything possible that the ASSIGNEE shall

consider desirable for vesting title to such improvements in the ASSIGNEE, and to secure, maintain, defend and enforce valid and enforceable patent protection for such improvements;

AGREE AND ACKNOWLEDGE that the SALE, ASSIGNMENT AND TRANSFER of rights and property set forth herein is and shall be IRREVOCABLE and BINDING upon the heirs, assigns, representatives and successors of each undersigned ASSIGNOR and EXTEND to the successors, assigns and nominees of the ASSIGNEE.

ASSIGNORS:		
Song Guo Residing at: 10814 West Alfina Drive, Boise, ID 83709	Date:	
Sanh D. Tang Residing at: 2725 E. Deer Flat Rd., Kuna, ID 83634	Date: <u>15-2018</u>	?
Vlad Temchenko Residing at: 100 East Parkway Drive, Boise, ID 83706	Date:	
Shivani Srivastava Residing at: 4068 S. Federal Way, Apt. #I-107, Boise, ID	Date:	***************************************

Attorney Docket No. 2269-P14271US (2016-0775.00/US)

ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, each undersigned ASSIGNOR does hereby:

SELL, ASSIGN AND TRANSFER to MICRON TECHNOLOGY, INC. ("ASSIGNEE"), a Corp[oration of the State of Delaware, having a place of business at 8000 South Federal Way, Mailstop 1-507, Boise, ID 83707-0006, the entire right, title and interest for the United States and all foreign countries in and to any and all improvements that are disclosed in the Application for United States Letters Patent that has been executed by each undersigned ASSIGNOR concurrently herewith, and titled METHODS OF FORMING SEMICONDUCTOR DEVICES USING ASPECT RATIO DEPENDENT ETCHING EFFECTS, AND RELATED SEMICONDUCTOR DEVICES, MEMORY DEVICES, AND ELECTRONIC SYSTEMS, such application and all divisional, continuing, substitute, renewal, reissue and all other applications for patent or the legal equivalent thereof that have been or may be filed in the United States and all foreign countries relating to any of such improvements; all original, reexamined and reissued patents that have been or shall be issued in the United States and all foreign applications under the provisions of any convention or treaty and claim priority based on such application made in the United States;

AUTHORIZE the ASSIGNEE to apply for and receive any and all United States and foreign patents relating to such improvements in its own name;

AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to and in the name of the ASSIGNEE:

WARRANT AND COVENANT that no assignment, grant, mortgage, license or other agreement or encumbrance affecting the rights and property herein convoyed has been or will be made or entered into by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT, when requested and at the expense of the ASSIGNEE, to carry out in good faith the intent and purpose of this Assignment, to execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications relating to any and all such improvements; to execute all rightful oaths, declarations, assignments, powers of attorney and other papers, to communicate to the ASSIGNEE all facts and provide to the ASSIGNEE all documents and things known and accessible to the undersigned relating to such improvements and the history thereof, and testify as to the same in any interference, fligation or other proceeding relating thereto; and generally to do everything possible that the ASSIGNEE shall

consider desirable for vesting title to such improvements in the ASSIGNEE, and to secure, maintain, defend and enforce valid and enforceable patent protection for such improvements:

AGREE AND ACKNOWLEDGE that the SALE, ASSIGNMENT AND TRANSFER of rights and property set forth herein is and shall be IRREVOCABLE and BINDING upon the heirs, assigns, representatives and successors of each undersigned ASSIGNOR and EXTEND to the successors, assigns and nominees of the ASSIGNEE.

ASSIGNORS:	
Song Guo Residing at: 10814 West Alfina Drive, Boise, ID 83709	Date:
Sanh D. Tang Residing at: 2725 E. Deer Flat Rd., Kuna, 1D 83634	Date:
Vlad Teopeteenko Residing at: 100 East Parkway Drive, Boise, ID 83706	Date: <u>28/08/2<i>01</i>8</u>
Hivmì Srivastava	Date:

3

Residing at: 4068 S. Federal Way, Apr. #1-107. Boise, ID 83716

ASSIGNMENT

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, each undersigned ASSIGNOR does hereby:

SELL, ASSIGN AND TRANSFER to MICRON TECHNOLOGY, INC. ("ASSIGNEE"), a Corp[oration of the State of Delaware, having a place of business at 8000 South Federal Way, Mailstop 1-507, Boise, ID 83707-0006, the entire right, title and interest for the United States and all foreign countries in and to any and all improvements that are disclosed in the Application for United States Letters Patent that has been executed by each undersigned ASSIGNOR concurrently herewith, and titled METHODS OF FORMING SEMICONDUCTOR DEVICES USING ASPECT RATIO DEPENDENT ETCHING EFFECTS, AND RELATED SEMICONDUCTOR DEVICES, MEMORY DEVICES, AND ELECTRONIC SYSTEMS, such application and all divisional, continuing, substitute, renewal, reissue and all other applications for patent or the legal equivalent thereof that have been or may be filed in the United States and all foreign countries relating to any of such improvements; all original, reexamined and reissued patents that have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application made in the United States;

AUTHORIZE the ASSIGNEE to apply for and receive any and all United States and foreign patents relating to such improvements in its own name;

AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to and in the name of the ASSIGNEE;

WARRANT AND COVENANT that no assignment, grant, mortgage, license or other agreement or encumbrance affecting the rights and property herein conveyed has been or will be made or entered into by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT, when requested and at the expense of the ASSIGNEE, to carry out in good faith the intent and purpose of this Assignment, to execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications relating to any and all such improvements; to execute all rightful oaths, declarations, assignments, powers of attorney and other papers; to communicate to the ASSIGNEE all facts and provide to the ASSIGNEE all documents and things known and accessible to the undersigned relating to such improvements and the history thereof, and testify as to the same in any interference, litigation or other proceeding relating thereto; and generally to do everything possible that the ASSIGNEE shall

consider desirable for vesting title to such improvements in the ASSIGNEE, and to secure, maintain, defend and enforce valid and enforceable patent protection for such improvements;

AGREE AND ACKNOWLEDGE that the SALE, ASSIGNMENT AND TRANSFER of rights and property set forth herein is and shall be IRREVOCABLE and BINDING upon the heirs, assigns, representatives and successors of each undersigned ASSIGNOR and EXTEND to the successors, assigns and nominees of the ASSIGNEE.

Song Guo Residing at: 10814 West Alfina Drive, Boise, ID 83709	Date:
Sanh D. Tang Residing at: 2725 E. Deer Flat Rd., Kuna, ID 83634	Date;
Vlad Temchenko Residing at: 100 East Parkway Drive, Boise, ID 83706	Date:
Shivani Srivastava Residing at: 4068 S. Federal Way, Apt. #1-107, Boise, ID 8	Date: <u>2/23/2018</u>

1

PATENT REEL: 047139 FRAME: 0939

RECORDED: 09/25/2018